

SiI9135/SiI9235A HDMI Receiver with Enhanced Audio and Deep Color Outputs

Data Brief

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Introduction

The SiI9135/SiI9235A HDMI Receiver with Enhanced Audio and Deep Color Outputs is a second-generation dual-input High Definition Multimedia Interface (HDMI) receiver. It is software-compatible with the SiI9133 receiver, but adds audio support for DTS-HD and Dolby TrueHD. Digital televisions that can display 10- or 12-bit color depth can now provide the highest quality protected digital audio and video over a single cable. The SiI9135 and SiI9135A devices, which are functionally identical, can receive Deep Color video up to 12-bit, 1080p @ 60 Hz. Backward compatibility with the DVI 1.0 specification allows HDMI systems to connect to existing DVI 1.0 hosts, such as HD set-top boxes and PCs. Silicon Image HDMI receivers use the latest generation Transition Minimized Differential Signaling (TMDS) core technology that runs at 25-225 MHz.

The chip comes pre-programmed with High-bandwidth Digital Content Protection (HDCP) keys for receiving protected audio and video content. This set of keys simplifies the manufacturing process and lowers costs while providing the highest level of HDCP key security.

The SiI9135/SiI9135A receiver can send and receive up to eight channels of uncompressed digital audio at 192 kHz and 2-channel digital audio up to 192 kHz. Compressed streams are also supported through either the S/PDIF port or over I²S for DTS-HD and Dolby TrueHD. An industry-standard I²S port allows direct connection to low-cost audio DACs at up to 192 kHz. An S/PDIF port supports up to 192 kHz audio. The device supports Super Audio Compact Disc (SACD) and provides Direct Stream Digital (DSD) ports that support 44.1 and 88.2-kHz one-bit audio.

A low-power standby feature of the SiI9135/SiI9135A receiver enables flexible power management.

Digital Video Interface

- Flexible support for many different standard- and high-definition video formats (36-bit RGB / YCbCr 4:4:4, 16/20/24-bit YCbCr 4:2:2, 8/10/12bit YCbCr 4:2:2 (ITU BT.656))
- 12/15/18-bit Digital Multimedia Output (DMO) RGB/YCbCr 4:4:4 (clocked with rising and falling edges)
- Color Space Conversion for both RGB-to-YCbCr and YCbCr-to-RGB (both 601 and 709)
- True 12-bit accurate data using 14-bit processing
- Auto video mode configuration simplifies system firmware design

Digital Audio Interface

- DTS-HD and Dolby TrueHD high bit rate audio
- Four I²S inputs accept Dolby Digital, DVD-Audio input (2-channel 192 kHz and 8-channel 192 kHz)
- S/PDIF input supports PCM, Dolby Digital, DTS digital audio transmission (32–192 kHz Fs sample rate)
- IEC60958 or IEC61937 compatible
- Flexible, programmable I²S channel mapping

HDCP Decryption

- Pre-programmed HDCP keys provide the highest level of key security, simplify manufacturing, and lower cost
- Full support for HDCP repeaters (up to 16 attached downstream devices)

Package

• 20 mm x 20 mm 144-pin TQFP package with ePadTM

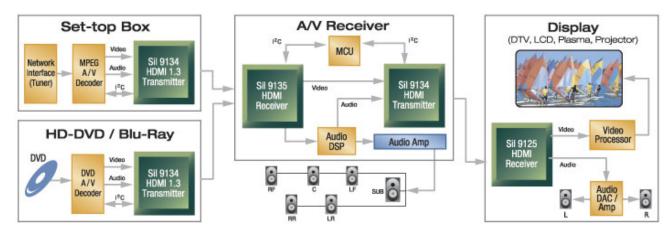


Figure 1. Typical Application of SiI9135/SiI9135A Receiver

System Applications

The SiI9135/SiI9135A receiver is designed for AV receivers that require support for HDMI Deep Color and the latest audio technologies: DTS-HD and Dolby TrueHD. The receiver allows receiving 10/12-bit color depth up to 1080p resolutions. A single device provides two HDMI input ports. The video output goes to a video processor or HDMI transmitter. Besides DTS-HD and Dolby TrueHD, the device supports full surround sound audio including DVD-Audio and SACD. The audio output can go directly to an audio DAC or an audio digital signal processor for further processing.

Comparing the SiI9135/SiI9135A Receiver with the SiI9033 and SiI9133 Receivers

Table 1 summarizes the functional differences among the SiI9033, the SiI9133, and the SiI9135/SiI9135A receivers.

Table 1. Summary of New Features

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Feature	SiI9033	SiI9133	SiI9135/SiI9135A
HDMI Input Connections			
TMDS Input Ports	2	2	2
Color Depth	8-bit	8/10/12-bit	8/10/12-bit
DDC Input Ports	2	2	2
Maximum TMDS Input Clock	165 MHz	225 MHz	225 MHz
Output Ports			
Digital Video Output Ports	1	1	1
Maximum Output Pixel Clock	165 MHz.	165 MHz.	165 MHz.
Maximum Output Bus Width	24	36	36
Analog Video Output Ports	0	0	0
S/PDIF Output Ports	1	1	1
I ² S Output	8 channel	8 channel	8 channel
DSD Output	8 channel	8 channel	6 channel
Video Processing			
Color Space Converter	RGB to/from YcbCr	RGB to/from YcbCr	RGB to/from YcbCr
Pixel Clock Divider	0.25, 0.5	0.25, 0.5	0.25, 0.5
Digital Video Bus Mapping	swap Cb, Cr pins	swap Cb, Cr pins	swap Cb, Cr pins
Maximum Audio Sample Rate (Fs)			
2-channel (I ² S or S/PDIF)	192 kHz	192 kHz	192 kHz
8-channel (I ² S)	192 kHz	192 kHz	192 kHz
8-channel (DSD)	88.2 kHz	88.2 kHz	88.2 kHz (6 channel)
High Bit Rate Audio Support Compressed DTS-HD and Dolby True-HD	No	No	Yes
Other Features			
MCLK Generation	No external connection required.	No external Connection required	No external connection required.
HDCP Repeater Support	Yes	Yes	Yes
Interlaced Format Detection Pin	Yes	Yes	Yes
TMDS R _{EXT_SWING}	Not Used	Not Used	Not Used
Package	144-pin TQFP ePad	404-pin BGA w/Heat Slug	144-pin TQFP ePad

Pin Diagrams

Figure 2 shows the SiI9135/SiI9135A pin assignments of the receiver. Pin names are generalized by type for this document. The list below the diagram describes the purpose of each type. The package is a 20 mm x 20 mm 144-pin TQFP with an ePad.

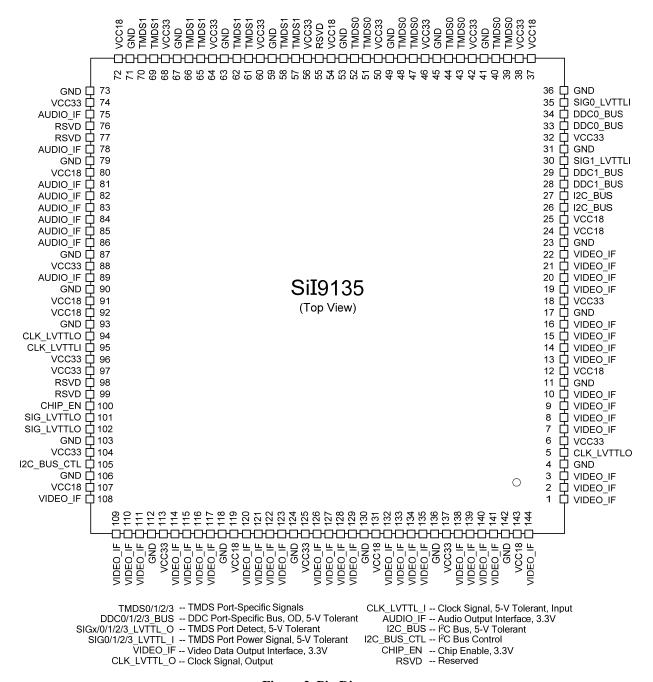
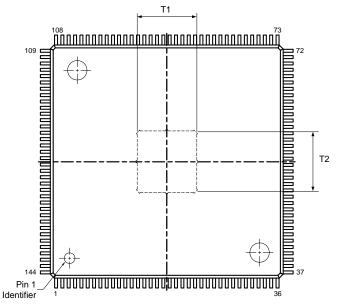


Figure 2. Pin Diagram

Packaging

ePad Enhancement

The SiI9135/SiI9135A receiver is packaged in a 144-pin TQFP package with an ePadTM. The ePad dimensions are shown in Figure 3.



Silicon Image recommends that the ePad be soldered to the PCB and electrically grounded on the PCB. The ePad must not be connected to any other voltage level.

Figure 3. ePad Diagram

ePad Dimensions: Amkor and SPIL

Item	Description	Тур	Max
T1	ePad height	4.60	4.64
T2	ePad width	5.20	5.24

ePad Dimensions: ASE

Item	Description	Тур	Max
T1	ePad height	5.25	5.29
T2	ePad width	5.25	5.29

All dimensions are in millimeters.

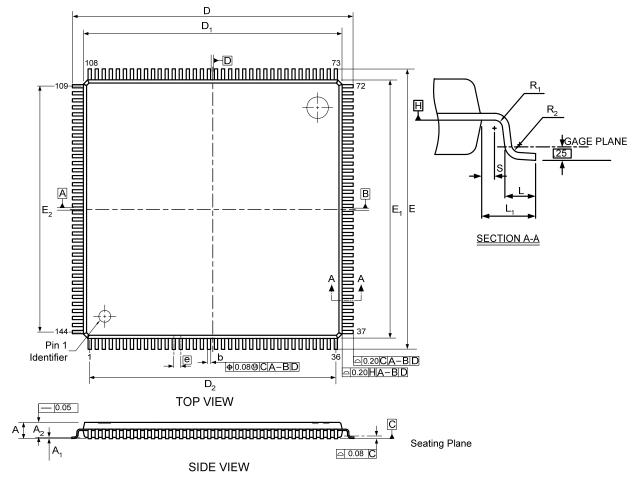
The ePad is centered on the package center lines. The measurement tolerance is ± 0.04 mm for all manufacturers. The ePad tab dimensions may vary.

A clearance of at least 0.25 mm should be provided on the PCB between the edge of the ePad and the inner edges of the lead pads to avoid the possibility of electrical shorts.

PCB Layout Guidelines

PCB layout designers should refer to Silicon Image application note *PCB Layout Guidelines: Designing with Exposed Pads* for basic design guidelines when designing with thermally enhanced packages using the Exposed Pad.

144-pin TQFP Package Dimensions



JEDEC Package Code MS-026-AFB

Item	Description	Min	Тур	Max
A	Thickness	1.00	1.10	1.20
A1	Stand-off	0.05	0.10	0.15
A2	Body thickness	0.95	1.00	1.05
D	Footprint	2	22.00 BSC	7
Е	Footprint	2	22.00 BSC	2
D_1	Body size	2	20.00 BSC	7
E_1	Body size	1	20.00 BSC	7
D_2	Lead Row Width		17.5 BSC	
E_2	Lead Row Width		17.5 BSC	•

Description	Min	Тур	Max
Lead width	0.17	0.22	0.27
Lead thickness	0.09	_	0.20
Lead pitch		0.50 BSC	
Lead foot length	0.45	0.60	0.75
Total lead length		1.00 REF	
Lead radius, inside	0.08	_	
Lead radius, outside	0.08	_	0.20
Lead horizontal run	0.20	_	_
	Lead width Lead thickness Lead pitch Lead foot length Total lead length Lead radius, inside Lead radius, outside	Lead width 0.17 Lead thickness 0.09 Lead pitch 0.45 Total lead length 0.08 Lead radius, inside 0.08 Lead radius, outside 0.08	Lead width0.170.22Lead thickness0.09—Lead pitch0.50 BSCLead foot length0.450.60Total lead length1.00 REFLead radius, inside0.08—Lead radius, outside0.08—

Dimensions in millimeters.

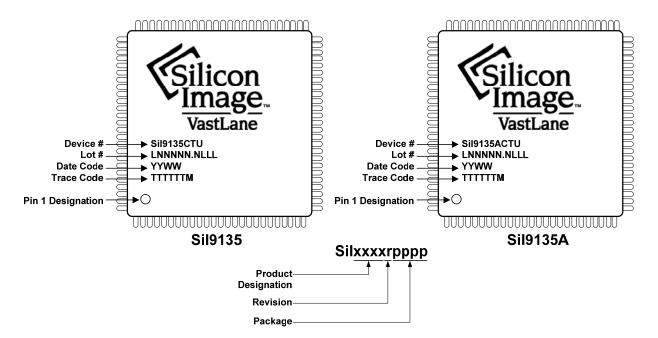
Overall thickness A = A1 + A2.

Figure 4. Package Diagram

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Marking Specification

Drawing is not to scale and pin count shown is representative. Refer to specifics in Figure 4 on page 5.



Legend	Description
LNNNNN.NLLL	Lot number
YY	Year of manufacture
WW	Week of manufacture
TTTTTT	Trace code
M	Maturity code

Figure 5. Marking Diagram

The universal package may be used in lead-free and ordinary process lines

Ordering Information

Production Part Numbers:

TMDS Input Clock Range	Part Number
25–225 MHz	SiI9135CTU
25–225 MHz	SiI9135ACTU

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